



## Material Content Data Sheet



<b>Sales Product Name</b>				SAK-XC2268I-136F128LR AA		<b>Issued</b>		24. January 2018	
<b>MA#</b>				MA001262124					
<b>Package</b>				PG-LQFP-100-15		<b>Weight*</b>		752.91 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	56.102	7.45	7.45	74514	74514	
leadframe	inorganic material	phosphorus	7723-14-0	0.068	0.01		91		
	non noble metal	zinc	7440-66-6	0.273	0.04		363		
	non noble metal	iron	7439-89-6	5.459	0.72		7250		
wire	non noble metal	copper	7440-50-8	221.639	29.44	30.21	294379	302083	
	noble metal	palladium	7440-05-3	0.025	0.00		33		
	non noble metal	copper	7440-50-8	2.458	0.33	0.33	3265	3298	
encapsulation	organic material	carbon black	1333-86-4	2.205	0.29		2928		
	plastics	epoxy resin	-	59.529	7.91		79065		
	inorganic material	silicondioxide	60676-86-0	379.219	50.37	58.57	503673	585666	
leadfinish	noble metal	palladium	7440-05-3	0.002	0.00		2		
	noble metal	silver	7440-22-4	0.001	0.00		2		
	noble metal	gold	7440-57-5	0.003	0.00		4		
	non noble metal	nickel	7440-02-0	2.734	0.36	0.36	3631	3639	
plating	noble metal	silver	7440-22-4	0.006	0.00		8		
	noble metal	gold	7440-57-5	0.011	0.00		14		
	noble metal	palladium	7440-05-3	0.007	0.00		9		
	non noble metal	nickel	7440-02-0	10.653	1.41	1.41	14149	14180	
glue	plastics	epoxy resin	-	3.128	0.42		4155		
	noble metal	silver	7440-22-4	9.385	1.25	1.67	12465	16620	
*deviation	< 10%		Sum in total:			100.00		1000000	

### Important Remarks:

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